

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Chuh-Yung Chen	11/05/2009
Cheng-Chien Wang	10/28/2009
I-Han Chen	11/05/2009
Chia-Chun Liao	11/05/2009
Szu-Wen Chen	11/05/2009
Chun-Liang Lee	11/05/2009
RECEIVING PARTY DATA	
Name:	Chi Lin Technology Co., Ltd.
Street Address:	No.18 Sheng Li 1st St., Jen Te Hsiang,
City:	Tainan County
State/Country:	TAIWAN
Postal Code:	717
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12622436
CORRESPONDENCE DATA	
Fax Number:	(949)660-0809
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Email:	Usa@cipgroup.com.tw
Correspondent Name:	JIANQ CHYUN INTELLECTUAL PROPERTY OFFICE
Address Line 1:	7F.-1, NO.100, ROOSEVELT RD., SEC. 2,
Address Line 4:	Taipei, TAIWAN 100
ATTORNEY DOCKET NUMBER:	27416-US-PA
NAME OF SUBMITTER:	Belinda Lee

CH \$40.00 12622436

Total Attachments: 2

source=27416-Assignment#page1.tif

source=27416-Assignment#page2.tif

ASSIGNMENT

WHEREAS,

- | | |
|--------------------|----------------------|
| 1. Chen, Chuh-Yung | 2. Wang, Cheng-Chien |
| 3. Chen, I-Han | 4. Liao, Chia-Chun |
| 5. Chen, Szu-Wen | 6. Lee, Chun-Liang |

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **NANOCOMPOSITE MATERIAL APPARATUS, NANOCOMPOSITE MATERIAL AND METHOD FOR FABRICATING THEREOF, NANO MATERIAL APPARATUS AND NANO MATERIAL**

Filed: Serial No.

Executed concurrently with the execution of this instrument

WHEREAS, Chi Lin Technology Co., Ltd.

of No.18 Sheng Li 1st St., Jen Te Hsiang, Tainan County 717

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assign **PATENT**

REEL: 023603 FRAME: 0211

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Chen Chuh-Yung
Sole or First Joint Inventor: Chen, Chuh-Yung

Date: 2009/11/5

Signature: Wang, Cheng-Chien
Second Joint Inventor (if any): Wang, Cheng-Chien

Date: 2009/10/28

Signature: Chen, I-Han
Third Joint Inventor (if any): Chen, I-Han

Date: 2009/11/5

Signature: Liao, Chia-Chun
Fourth Joint Inventor (if any): Liao, Chia-Chun

Date: 2009/11/5

Signature: Chen, Szu-Wen
Fifth Joint Inventor (if any): Chen, Szu-Wen

Date: 2009/11/5

Signature: Lee, Chun-Liang
Sixth Joint Inventor (if any): Lee, Chun-Liang

Date: 2009.11.5